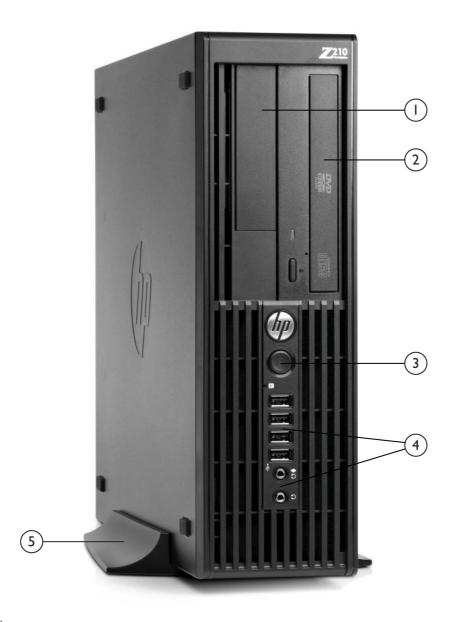
Overview



- 1. External 3.5" Bay
- 2. External 5.25" Bay
- 3. Power button
- 4. Standard Front I/O: 4 USB 2.0, headphone, microphone
- 5. Tower stand (optional)

Form Factor	Small Form Factor
Operating Systems	Genuine Windows® 7 Ultimate 64-bit
' ' '	Genuine Windows® 7 Professional 32-Bit
	Genuine Windows® 7 Professional 64-Bit



Overview

NOTES: Systems may require upgraded and/or separately purchased hardware and/or DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

HP Linux Installer Kit for Linux

fincludes drivers for 32-bit & 64-bit OS versions of

Red Hat Enterprise Linux (RHEL) 5 Workstation,

Red Hat Enterprise Linux (RHEL) 6 Workstation,

64-bit Novell SUSE Linux Enterprise Desktop (SLED) 11]

See http://www.hp.com/workstations/software/linux for details.

Novell SLED 11 Linux Preloaded

Red Hat Enterprise Linux WS5 (Paper Licence drop-in-the-box only)

For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux hardware matrix

Windows® XP 32-bit/ 64-bit OS and drivers supported; not available pre-installed

Available Processors

Intel® Xeon® processor E3-1280, 3.50 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1270, 3.40 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1245, 3.30 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT,

Intel® HD Graphics P3000, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1240, 3.30 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1230, 3.20 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel® vPro Technology

Intel® Xeon® processor E3-1225, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel® HD Graphics P3000, featuring Intel® vPro Technology

Intel® Core i7-2600 processor, 3.40 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT,

Intel® HD Graphics 2000, featuring Intel® vPro Technology

Intel® Core i5-2500 processor, 3.30 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel® HD Graphics 2000, featuring Intel® vPro Technology

Intel® Core i5-2400 processor, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel® HD Graphics 2000,featuring Intel® vPro Technology

Intel® Core i3-2120 processor, 3.30 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT,

Intel® HD Graphics 2000 Intel® Core i3-2100 processor, 3.10 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT, Intel® HD Graphics 2000

Intel Pentium processor G850, 2.9 GHz, 65W, 3MB cache, 1333 MHz memory, Dual-Core, Intel HD Graphics 2000

Intel Pentium processor G620, 2.6 GHz, 65W, 3MB cache, 1066 MHz memory, Dual-Core, Intel HD Graphics 2000

Available Processor Disclaimers

Integrated Intel® HD graphics is not supported on the Intel® Xeon E3-1230, E3-1240, E3-1270 or E3-1280 Processors.

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See:

http://www.intel.com/products/processor number/ for details.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not



Overview

Overview		
Calaa	vary depending on you more information. Dual-Core and Quad- software products and operating system software customers or software	bit operation) without an Intel 64 architecture-enabled BIOS. Performance will bur hardware and software configurations. See: http://www.intel.com/info/em64t for Core technologies are designed to improve performance of multithreaded hardware-aware multitasking operating systems and may require appropriate are for full benefits; check with software provider to determine suitability; Not all applications will necessarily benefit from use of these technologies.
Color	Jack Black	
Convertibility	tower stand.	ner be placed flat on the desktop or made to stand on the desk with the optional
Expansion Slots (see system board section for more details)	• 1 PCI Express G • 1 PCI Express G	Gen2 slot x1 mechanical/x1 electrical (Low Profile) Gen2 slot x16 mechanical/ x16 electrical (Low Profile, dedicated for graphics) Gen2 slot x16 mechanical/x4 electrical (Low Profile) Profile)
Expansion Bays (see	• 1 internal 3.5" k	pay, and 1 shared internal/external 3.5" bay.
storage section for more details)	• 1 external 5.25	· · · · · · · · · · · · · · · · · · ·
Front I/O	4 USB 2.0, 1 Headph Headphone.	one, and 1 Microphone; Microphone can be re-tasked to function as Line-in or
Internal I/O	4 USB 2.0 ports availa	able by two separate 9-pin headers
Rear I/O	2.0, 1 standard and 1	Port output from Intel HD graphics (available on specific processors only); 6 USB optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Linebut; Line-in can be re-tasked to function as Microphone.
Interfaces Supported	22-in-1 Media Card R	leader (optional)
Chassis Dimensions (H x W x D)		ntation: 100 x 338 x 381 mm (3.95 x 13.3 x 15.0 in); Optional SFF Tower stand dimension): 338 x 100 x 381 mm (13.3 x 3.95 x 15.0 in)
Weight		(16.72 lbs)
Temperature	Operating:	40° to 95°F (5° to 35°C)
	Non-operating:	-40° to 140°F (-40° to 60°C)
Humidity	Operating:	8% to 85%
	Non-operating:	8% to 90%
Maximum Altitude (non-	Operating:	3,000 m (10,000 ft)
pressurized)	Non-operating:	9,100 m (30,000 ft).
Power Supply		g, active Power Factor Correction, 90% Efficient iency Report for this product may be found at these links:
Backup Devices	For a complete listing System offerings, pleas	of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup se visit: http://www.hp.com/go/connect
Chipset	Intel® C206 chipset	
Memory		ing up to 32GB** ECC/16GB non-ECC, DDR3 1333 MHz are available, estimated Q4 2011)



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel® Xeon® processor E3 family (Z210)				
	Intel Xeon processor E3-1280, 3.50 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology	Y	N		Supported with either ECC or non-ECC memory
	Intel Xeon processor E3-1270, 3.40 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology	Y	N		Supported with either ECC or non-ECC memory
	Intel Xeon processor E3-1245, 3.30 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, HD Graphics P3000, featuring Intel vPro Technology	Y	N		Supported with either ECC or non-ECC memory
	Intel Xeon processor E3-1240, 3.30 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology	Y	N		Supported with either ECC or non-ECC memory
	Intel Xeon processor E3-1230, 3.20 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology	Y	N		Supported with either ECC or non-ECC memory
	Intel Xeon processor E3-1225, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, HD Graphics P3000, featuring Intel vPro Technology	Y	Ν		Supported with either ECC or non-ECC memory
	2nd generation Intel® Core™ processor family				
	Intel Core i7-2600 processor, 3.40 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, Intel HD Graphics 2000, featuring Intel vPro Technology	Y	Ν		Supported only with non-ECC memory
	Intel Core i5-2500 processor, 3.30 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel HD Graphics 2000, featuring Intel vPro Technology	Υ	Ν		Supported only with non-ECC memory
	Intel Core i5-2400 processor, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel HD Graphics 2000, featuring Intel vPro Technology	Y	Ν		Supported only with non-ECC memory



Supported Components

Intel Core i3-2120 processor, 3.30 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT, Intel HD Graphics 2000	Y	N	Supported with either ECC or non-ECC memory
Intel Core i3-2100 processor, 3.10 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT, Intel HD Graphics 2000	Y	N	Supported with either ECC or non-ECC memory
Dual-Core Intel Pentium processors (Z210)			
Intel Pentium processor G850, 2.9 GHz, 65W, 3MB cache, 1333 MHz memory, Dual-Core, Intel HD Graphics 2000	Y	N	Supported with either ECC or non-ECC memory
Intel Pentium processor G620, 2.6 GHz, 65W, 3MB cache, 1066 MHz memory, Dual-Core, Intel HD Graphics 2000	Y	Ν	Supported with either ECC or non-ECC memory

Intel HD Graphics P3000 provides improved desktop performance and supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications*, compared to Intel HD Graphics 2000.

Hard Drives SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA	
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	160GB SATA 10K rpm SFF in 3.5" Frame HDD	Υ	Υ	EW222AA	
	300GB SATA 10K rpm SFF in 3.5" Frame HDD	Υ	Υ	FM802AA	
	600GB SATA 10K rpm SFF in 3.5" Frame HDD	Υ	Υ	XP309AA	
SATA Solid State Drives	HP Solid State Drive for Workstations				
	HP 160GB SATA X25-M SSD	Υ	Υ	WV915AA	

Supported Components

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA Controller (Z210)				
	Integrated SATA Controller (SFF), RAID 0,1 supported: 2 ports 3 Gb/s, 2 ports 6 Gb/s	Υ	Ν		
	Factory integrated RAID on motherboard for SA	ΓA drives			
	RAID 0 Configuration - Striped Array	Υ	Ν		
	RAID 1 Configuration - Mirrored Array	Υ	Ν		
	SATA hardware RAID is not supported on Linux sy	stams The Linux ka	rnel with buil	t_in software R	AID

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit: http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

All drives must be identical in type and capacity

All RAID arrays must be less than 2 TB

NOTE 1: Requires identical hard drives (speeds, capacity, interface).

Graphics	
Integrated	Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
Integrated Intel HD Graphics Media Accelerate	ors (Z210)				
Intel HD Graphics 2000	Y	Ν		Available on Intel Core i3/i5/i7 processors only	1
Intel HD Graphics P3000	Y	N		Available on Intel Xeon E3- 12x5 processors only	1
Professional 2D				,	
NVIDIA Quadro NVS 295 256MB PCle Graphics Card	Υ	Υ	FY943AA		2
NVIDIA NVS300 512MB PCle Graphics Card	Υ	Υ	XP612AA		2
AMD FirePro 2270 512MB Graphics Card	Υ	Υ	LA524AA		2
Entry 3D					
ATI FirePro V3800 512MB PCle Graphics Card	ΙΥ	Υ	WL048AA		1
NVIDIA Quadro 400 512MB Graphics Card	Υ	Υ	LD542AA		1
NVIDIA Quadro 600 1GB Graphics Card	Υ	Υ	WS093AA		1
Laborate transfer to the Laborate Library and	1	1. •			

Intermixing integrated Intel HD graphics and discrete graphics cards in order to drive more than two displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics cards when attaching three or more displays.



Support Notes

QuickSpecs

Supported Components

Memory

Sub-Section Description/Notes

CTO

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Option Kit Part

OC951 A A

	Number	ооррон г
PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO		
2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		
PC3-10600 DDR3-1333 nECC Unbuffered DIMMs CTO		
1 GB (1x1GB) DDR3-1333 nECC Unbuffered RAM 1-CPU		
2 GB (2x1GB) DDR3-1333 nECC Unbuffered RAM 1-CPU		
4 GB (2x2GB) DDR3-1333 nECC Unbuffered RAM 1-CPU		
8 GB (4x2GB) DDR3-1333 nECC Unbuffered RAM 1-CPU		
8 GB (2x4GB) DDR3-1333 nECC Unbuffered RAM 1-CPU		

Sub-Section Description/Notes

Two channels of DDR3 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066 MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the specified speed of the memory.

AMO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO

16 GB (4x4GB) DDR3-1333 nECC Unbuffered RAM 1-CPU

Tr ZZTO TGB (TXTGB) DDR3-1333 ECC UNDUTTERED RAIVI	QC05TAA
HP Z210 2GB (1x2GB) DDR3-1333 ECC Unbuffered RAM	QC447AA
HP Z210 4GB (1x4GB) DDR3-1333 ECC Unbuffered RAM	QC852AA
PC3-10600 DDR3-1333 nECC Unbuffered DIMMs AMO	
HP 1GB DDR3-1333 non-ECC UDIMM	XC497AA
HP 2GB DDR3-1333 non-ECC UDIMM	XC440AA
HP 4GB DDR3-1333 non-ECC UDIMM	LB435AA

NOTE: Only unbuffered DDR3 DIMMs are supported.



Suppo	rted	Com	pone	ents

Multimedia and Audio Devices	a and Audio		Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel/Realtek HD ALC261 Audio	Υ	Ν		
	HP Thin USB Powered Speakers, BFR-PVC free	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit		oport otes
	HP 16X DVD-ROM SATA Drive	Υ	Υ	EW268AA See	note
	HP 16X DVD+/-RW SuperMulti SATA Drive	Υ	Υ	EW269AA	
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA	
	HP Blu-ray Writer	Υ	Υ	AR482AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards		Factory Configured	Option Kit	Option Support Kit Part Notes Number
	HP FireWire IEEE 1394a PCIe x1 Card	Υ	Y	BW851AA This card is only supported on Slots 1 or 2
	For the 7210 SFF Workstation, this card is only supported	l on Slots 1 or 2)	



Supported Components

Monitors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP ZR24w 24-inch S-IPS LCD Monitor	Ν	Υ	VM633A8	
	HP ZR22w 21.5-inch S-IPS LCD Monitor	Ν	Υ	VM626A8	
	HP LP3065 30-inch Widescreen LCD Monitor	Ν	Υ	EZ320A	
	HP LP2475w 24-inch Widescreen LCD Monitor	Ν	Υ	KD911A	
	HP LP2275w 22-inch Widescreen LCD Monitor	Ν	Υ	KE289A	
	HP DreamColor LP2480zx Professional Display	Ν	Υ	GV546A	
	HP LP2065 20-inch LCD Monitor	Ν	Υ	EF227A	
	Supported by all Operating Systems available from HP				
	Screen Size Diagonally Measured				

Networking and Communications		Factory Configured	•	Option Support Notes Kit Part Number
	Integrated Intel 82579LM PCIe GbE Controller	Υ	Ν	
	Intel Gigabit CT Desktop NIC	Υ	Υ	
	NOTE 1: "Gigabit" Ethernet indicates compliance with	IEEE standard 8	302.3ab f	or Gigabit Ethernet, and

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

The Intel Gigabit CT NIC is supported on the following operating systems: Microsoft Windows XP Pro 32-bit and 64-bit and Microsoft Windows 7 32-bit and 64-bit versions. Red Hat Enterprise Linux(RHEL), 5 Desktop/Workstation Novell SLED 10 & 11

NOTE 2: The integrated network connection is required to support Intel vPro Technology.

NOTE 3: If AMT is enabled network teaming with the built in LAN port is not possible.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Security Cable with Kensington Lock	Ν	Υ	PC766A	
	HP 2009 (SFF) Solenoid Lock and Hood Sensor	Υ	Υ		
	HP Business PC Security Lock Kit	Ν	Υ	PV606AA	



Supported Components

Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
	HP USB Smart Card Keyboard	Ν	Υ	ED707AA	
	HP USB CCID SmartCard Keyboard	Υ	Υ	BV813AA	
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Υ	NB896AA	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP SpaceExplorer 3D USB Controller	Ν	Υ	RY429AA	
Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Power Cord Kit	Ν	Υ	DM293A	
	HP Workstation Mouse Pad	Υ	Ν		Japan only
	HP Serial Port Adapter	Υ	Υ	PA716A	
	HP ENERGY STAR 5.0 Enabled Configuration	Υ	Ν		
	HP Parallel Port Adapter Kit	Ν	Υ	KD061AA	
	HP Internal USB Port Kit	Ν	Υ		
	HP eSATA PCI Cable Kit	Y	Υ	FH966AA	
Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Y	N		Supports Windows 7 only. Available as a web download, or preloaded with all Windows 7
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Y	Ν		preinstalls.
	Intervideo WinDVD (DVD player/burner software)	Υ	Ν		

Sur	norted	Com	ponents
JUP	poneu	COIII	honems

HP ProtectTools Security	Y	N	Available June 2011. Must be selected as a Configure to Order option. Delivered in the form of a "Drop in the Box" CD.
PDF Complete - Trial Edition	Υ	Ν	
HP Client Manager Software v6.2 (optional download)	Υ	Ν	
HP Support Assistant	Υ	Ν	
MS Office Home & Business 2010	Υ	Ν	

Operating Systems Support Notes

Genuine Windows® 7 Ultimate 64-bit

Genuine Windows® 7 Professional 32-bit See http://www.microsoft.com/windows/windows-7/ for

support details.

Genuine Windows® 7 Professional 64-bit See http://www.microsoft.com/windows/windows-7/ for

support details.

HP Linux Installer Kit See: http://www.hp.com/workstations/software/linux See http://www.redhat.com/rhel/desktop/

Red Hat Enterprise Linux (RHEL) Workstation

- Paper License (1yr)

Novell SLED 11 Linux Preload; http://www.novell.com/products/desktop

Windows XP 32-bit /64-bit OS and driver support available.



System Technical Specifications

System Board	
System Board Form Factor	BTX 21.2mm x 26.7mm
Processor Socket	Single LGA 1155
CPU Bus Speed	DMI
Chipset	Intel® PCH C206
Memory Expansion Slots	4 DDR3 memory slots
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC & non-ECC
Memory Modes	Non-Interleaved for single channel. Interleaved when both channels are populated.
Memory Speed Supported	1333MHz DDR3
Memory Protection	ECC available on data, parity on address and command
Memory	
Maximum Memory	16GB

MEMORY LOADING CONFIGURATIONS

Memory	16		9	
Size (GB)	DIMM1	DIMM2	DIMM3	DIMM4
1	1 GB			
2	1 GB		1 GB	3
3	1 GB	1 GB	1 GB	
4	2 GB		2 GB	
8	2 GB	2 GB	2 GB	2 GB
8	4 GB	1	4 GB	
16	4 GB	4 GB	4 GB	4 GB

Memory Configuration (Supported)	1GB, 2GB and 4GB E	CC and non-ECC unbuffered DIMMs are supported, but not if mixed.	
PCI Express Connectors	1 PCI Express Gen2 x1 1 PCI Express Gen2 x1 NOTE: LP = low profi	1 PCI Express Gen2 x16 LP slot (x16 electrical/x16 mechanical) 1 PCI Express Gen2 x16 LP slot (x4 electrical/x16 mechanical) 1 PCI Express Gen2 x1 LP slot (x1 electrical/x1 mechanical) NOTE: LP = low profile NOTES: In the PCIe x16 (x16 electrical/x16 mechanical) Gen 2 slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.	
PCI Connectors (5.0V)	1 PCI LP slot		
Supported Drive Interfaces	SATA	Integrated (4) Serial ATA interfaces (2x 6Gb/s SATA in blue, 2x 3Gb/s SATA in black). One port can optionally be used for eSATA. NOTE: the Z210 SFF supports a maximum of two SATA/SSD drives only. RAID 0 and 1 supported. (Factory integrated RAID is Microsoft Windows only).	
Serial Attached SCSI	None		



Integrated RAID	NOTE: Requires identical h	ard drives (speeds, capacity, interface)			
Integrated Graphics	Graphics P3000 (on Intel X Unified Memory Architectur graphics display. DirectX 10 graphics ports integrated in	Integrated Intel HD Graphics 2000 (on Intel Core i3/Core i5/Core i7 processors). Integrated Intel HD Graphics P3000 (on Intel Xeon E3-12x5 processors). Julified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display. DirectX 10.0 compliant; (OpenGL 3.0 on Intel HD Graphics P3000); 1 VGA & 1 DP graphics ports integrated in motherboard. Integrated graphics can support dual display across DP & VGA outputs.			
Network Controller	Integrated Gbit LAN MAC I and AMT 7	by Intel PHY Lewisville 82579LM; Management capabilities WOL, PXE 2.1			
External SATA (eSATA)	1 port eSATA capable with	optional eSATA After-Market Option cable kit.			
IDE connector	No				
Floppy connector	No				
Network Controller	Management capabilities V	VOL, PXE 2.1 and AMT 7			
Serial	1 rear port				
2nd Serial	Yes- requires optional Seric	ıl Port Adapter Kit			
Parallel	1 internal header (optional	parallel port adapter required)			
HD Integrated Audio	Yes				
CD-ROM input (Audio)	No				
AUX input (Audio)	No				
IEEE 1394 Connector(s)	Front	No			
	Rear	2 IEEE 1394a (requires optional PCIe card)			
	Internal	No			
USB Connector(s)	Front	4 USB 2.0			
	Rear	6 USB 2.0			
	Internal	4 USB 2.0			
HD Integrated Audio	Yes				
Flash ROM	Yes				
CPU Fan Header	Not applicable - passive C	PU heatsink			
Chassis Fan Header	Yes				
Front PCI Fan Header	Yes				
Front Control Panel/Speaker Header	Yes				
CMOS Battery Holder - Lithium	Yes				
Integrated Trusted Platform Module	Integrated TPM 1.2. The TPM module disabled	Integrated TPM 1.2. The TPM module disabled where restricted by law, i.e. Russia.			
Power Supply Headers	Yes				
Power Switch, Power LED & Hard Drive LED Header	Yes				
Clear Password Jumper	Yes				
Keyboard/Mouse	USB or PS/2				
Power Supply	240W, 90% efficiency				
Operating Voltage Range	90-264 VAC				



Rated Voltage Range	100-240 VAC						
Rated Line Frequency	50/60 Hz						
Operating Line Frequency Range	47-63 Hz						
Rated Input Current	4A @ 100-127V 2A @ 200-240V						
Heat Dissipation	oical 541 btu/hr 36.3 kg-cal/hr) aximum 1098 btu/hr 76.6 kg-cal/ hr)						
Power Supply Fan	92x25 mm variable speed						
ENERGY STAR® qualified (Config Dependent)	Yes						
80 PLUS Compliant	Yes, Gold.						
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off						
Power consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)	<4W						
Built-in Self Test (BIST) LED	No						
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes						
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5- Power Off)	Yes						
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5- Power Off)	Yes						



System Technical Specifications

Energy Consumption and Heat Dissipation: Configurations

System Configuration

Example Configuration #1 Memory Info

 Processor Info
 1x Intel Core i3-2120 3.3 3MB 2C 65W GT1 CPU

 Memory Info
 1GB (1x 1GB) 1333MHz DDR3 ECC

Graphics Info 1x ATI FireGL V3800 512MB PCle Graphics
Disks/Optical/Floppy 2x SATA 500GB 7.2k rpm / 1 Optical / 0 Floppy

PSU 240W 90% Rev 0A OS / BIOS Win7 32 / v0.57

Energy Consumption

	115	115 VAC		230 VAC		VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	33.9	9 W	34.8	3 W	34.3	3 W	
Windows Busy Typ(S0)	85.1 W		83.4 W		85.2 W		
Windows Busy Max (S0)	105.	105.1 W		100.4 W		106.6 W	
Sleep (S3)	2.21 W	1.83 W	2.39 W	2.00 W	2.20 W	1.81W	
Off (S5)	1.22 W	1.06 W	1.37 W	1.21 W	1.20 W	1.05 W	
Zero Power Mode (EuP)	0.17 W		0.27 W		0.16W		

Heat Dissipation**

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	115.7	btu/hr	118.7	btu/hr	117.0	btu/hr	
Windows Busy Typ(S0)	290.4 btu/hr		284.6 btu/hr		290.7 btu/hr		
Windows Busy Max (S0)	358.6	358.6 btu/hr		342.6 btu/hr		363.7 btu/hr	
Sleep (S3)	7.54 btu/hr	6.24 btu/hr	8.15 btu/hr	6.82 btu/hr	7.51 btu/hr	6.18 btu/hr	
Off (S5)	4.16 btu/hr	3.62 btu/hr	4.67 btu/hr	4.13 btu/hr	4.09 btu/hr	3.58 btu/hr	
Zero Power Mode (EuP)	0.58 btu/hr		0.92	btu/hr	0.55	btu/hr	

System Technical Specifications

Example Configuration #2 Memory Info

 Processor Info
 1x Intel Xeon E3-1280 3.5 8MB 4C 95W GT0 CPU

 Memory Info
 1x 2GB 1333MHz DDR3 ECC

Graphics Info
1x NVIDIA Quadro 600 1GB PCIe Graphics
Disks/Optical/Floppy
2x SATA 1000GB 7.2k rpm / 1 Optical / 0 Floppy

PSU 240W 90% Rev 0A OS /BIOS Win7 32 / v0.57

Energy Consumption

	115	115 VAC		230 VAC		VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	27.3	3 W	28.	1 W	27.4	W	
Windows Busy Typ(S0)	153.7 W		150.8 W		154.2 W		
Windows Busy Max (S0)	172.	172.5 W		170.3 W		176.2 W	
Sleep (S3)	2.32 W	2.26W	2.50 W	2.45 W	2.31 W	2.25W	
Off (S5)	1.22 W	1.06 W	1.37 W	1.21 W	1.20 W	1.05 W	
0.17 W	0.17 W		0.27 W		0.16W		

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	93.1	otu/hr	95.9	btu/hr	93.5	otu/hr
Windows Busy Typ(S0)	524.4 btu/hr		514.5 btu/hr		526.1 btu/hr	
Windows Busy Max (S0)	58836	btu/hr	581.1 btu/hr		601.2 btu/hr	
Sleep (S3)	7.92 btu/hr	7.71 btu/hr	8.53 btu/hr	8.36 btu/hr	7.88 btu/hr	7.68 btu/hr
Off (S5)	4.16 btu/hr	3.62 btu/hr	4.67 btu/hr	4.13 btu/hr	4.09 btu/hr	3.58 btu/hr
Zero Power Mode (EuP)	0.58 btu/hr		0.92 btu/hr		0.55 btu/hr	

Example Configuration

Processor Info 1x Intel Xeon E3-1280 3.5 8MB 4C 95W GT0 CPU

Memory Info 4x 4GB 1333MHz DDR3 ECC

Graphics Info 1x NVIDIA Quadro 600 1GB PCle Graphics
Disks/Optical/Floppy 2x SATA 1000GB 7.2k rpm / 1 Optical / 0 Floppy

PSU 240W 90% Rev 0A OS /BIOS Win7 64 / v0.57

Energy Consumption

	115	115 VAC		230 VAC		VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	34.7 W		35.3 W		35.1 W		
Windows Busy Typ(S0)	173.7 W		175.6 W		173.5 W		
Windows Busy Max (S0)	196.	196.8 W		190.2 W		198.5 W	
Sleep (S3)	2.79W	2.42 W	2.98 W	2.62 W	2.77 W	2.41 W	
Off (S5)	1.22 W	1.06 W	1.37 W	1.21 W	1.20 W	1.05 W	
Zero Power Mode (EuP)	0.17 W		0.27 W		0.16W		

Heat Dissipation**

	115 VAC		230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	118.4	btu/hr	120.4	btu/hr	119.8	btu/hr	
Windows Busy Typ(S0)	592.7 btu/hr		599.1 btu/hr		592.0 btu/hr		
Windows Busy Max (S0)	671.48	671.48 btu/hr		649.0 btu/hr		677.3 btu/hr	
Sleep (S3)	9.52 btu/hr	8.26 btu/hr	10.17 btu/hr	8.94 btu/hr	9.45 btu/hr	8.22 btu/hr	
Off (S5)	4.16 btu/hr	3.62 btu/hr	4.67 btu/hr	4.13 btu/hr	4.09 btu/hr	3.58 btu/hr	
Zero Power Mode (EuP)	0.58 btu/hr		0.92 btu/hr		0.55 btu/hr		

System Technical Specifications

Example
Configuration #4
(ENERGY STAR Qualified)

 Processor Info
 1x Intel Core i3-2120 3.3 3MB 2C 65W GT1 CPU

 Memory Info
 4x 4GB 1333MHz DDR3 nECC

Graphics Info Integrated Graphics

Disks/Optical/Floppy 2x SATA 1000GB 7.2k rpm / 1 Optical / 0 Floppy

PSU 240W 90% Rev 0A OS / BIOS Win7 64 / v0.57

Energy Consumption

	115	VAC	230	VAC	100	VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR® Idle (S0))	29.0	6 W	30.0	6 W	29.8	3 W
ENERGY STAR® P _{MAX} Windows running Linpack and Viewperf	212.17 W		208.04W		210.42 W	
ENERGY STAR® "Sleep" (S3)	2.74W	2.35 W	2.93 W	2.53 W	2.74 W	2.35 W
ENERGY STAR® "Standby" (Off) (S5)	1.22 W	1.06 W	1.37 W	1.21 W	1.20 W	1.05 W

Heat Dissipation**

	115	115 VAC		230 VAC		VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR® Idle (S0))	101.0	btu/hr	104.4	btu/hr	101.7	btu/hr
ENERGY STAR® P _{MAX} Windows running Linpack and Viewperf	723.9 btu/hr		709.8 btu/hr		718.0 btu/hr	
ENERGY STAR® "Sleep" (S3)	9.35 btu/hr	8.02 btu/hr	10.00 btu/hr	8.63 btu/hr	9.35 btu/hr	8.02 btu/hr
ENERGY STAR® "Standby" (Off) (S5)	4.16 btu/hr	3.62 btu/hr	4.67 btu/hr	4.13 btu/hr	4.09 btu/hr	3.58 btu/hr

NOTES:

^{**} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (Entry-level and High-end configurations)					
System Configuration	Processor Info	Intel Xeon E3-1270 3.4 GHz			
(Entry level)	Memory Info	2 x 2GB DDR3 1333 MHz			
	Graphics Info	NVIDIA Quadro NVS 300			
	Disks/Optical/Floppy	1 x 250 GB 7200 RPM SATA/ DVD-ROM			

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Desktop operator Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.3 Bels	22 dB
	Hard drive Operating	3.4 Bels	24 dB
	(random reads)		
	DVD-ROM Operating	5.0 Bels	40 dB
	(sequential reads)		



- <i> </i>	Processor Info	Intel Xeon E3-1280 3.5 GHz
(High-end)	Memory Info	4 x 4GB DDR3 1333 MHz
	Graphics Info	NVIDIA Quadro 600
	Disks/Optical/Floppy	2 x 300GB 10K rpm SATA/ DVD-ROM

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Desktop operator Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.6 Bels	27 dB
	Hard drive Operating (random reads)	4.0 Bels	30 dB
	DVD-ROM Operating (sequential reads)	5.0 Bels	40 db

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values represent individual shock events and do not indicate repetitive shock events. Values do not indicate continuous vibration.
	Cooling	Above 5,000 ft (1524 m) altitude, maximum operating temperature is derated by 1.8° F (1° C) per 1,000 ft (305 m) elevation increase

Physical Security an	Physical Security and Serviceability	
Access Panel	Tool-less Includes system board and memory information	
Expansion Cards	Tool-less	
Processor Socket	Tool-less, except for the processor heatsink.	
Green User Touch Points	Yes, on tool-free internal chassis mechanisms	
Color-coordinated Cables and Connectors	Yes	
Memory	Tool-less	
System Board	Screw-In	



i		
Dual Color Power and HD LED on Front of Computer	Yes	
<u> </u>	V	
Configuration Record SW	Yes	
Over-Temp Warning on Screen	Yes	
Restore CD/DVD Set	Restores the computer to its original factory shipping operating system. Orderable with the workstation, or available from Support.	
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds	
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system	
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system	
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system	
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.	
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft	
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports	
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)	
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation	
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration	
3.3V Aux Power LED on System PCA	Yes	
NIC LEDs (integrated) (Green & Amber)	Yes	
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less	
Power supply diagnostic LED	No	
Power Button	Yes, ACPI multi-function	
Power LED	Yes, blue (normal), red (fault)	
Hard drive activity LED	Yes, green	
Internal speaker	Yes	
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.	
Cooling Solutions	Air cooled forced convection	



Power Supply Fans	92 mm x 92 mm x 25 mm 4-wire PWM (non-serviceable)	
CPU Heatsink Fan(s)	Not applicable- CPU heatsink is passive.	
Chassis Fans	92 mm x 92mm x 25 mm 4-wire PWM	
Memory Fans	No	
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics utility must be booted from USB or CD, and enables you to perform testing and to view critical computer hardware and software configuration information from various sources.	
Access Panel Key Lock	No	
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).	
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 	
Trusted Platform Module Chip with optional ProtectTools Software	Yes	
Integrated Chassis Handles	No	
Power Supply	Tool-less	
PCI Card Retention	Yes, rear (all), middle (none), front (none)	
Flash ROM	Yes	
Diagnostic Power Switch LED on board	Yes	
Clear Password Jumper	Yes	
Clear CMOS Button	Yes	
CMOS Battery Holder for easy Replacement	Yes	
DIMM Connectors for easy Upgrade	Yes	
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux	

BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.



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System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Replicated Setup	Saves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).	
SMBIOS	System Management BIOS 2.7.1, for system management information.	
Boot Control	Disables the ability to boot from removable media on supported devices.	
Memory Change Alert	Alerts management console if memory is removed or changed.	
Thermal Alert	Monitors the temperature state within the chassis. Three modes:	
	 NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. 	
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.	
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.	
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.	
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.	
ASF 2.0 Compliant	No.	
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.	
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.	
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.	
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.	
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.	
Auto Setup when new hardware installed	System automatically detects addition of new hardware.	
Keyboard-less Operation	The system can be booted without a keyboard.	
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	
Asset Tag	TI ANCIA I I I I I I I I I I I I I I I I I I	
7 taser rag	The user or MIS to set a unique tag string in non-volatile memory.	
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.	



Intel® Active Management Technology (AMT)	AMT 7.0; Allows workstation status to be monitored on a remote console
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 1.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA II: Extensions to Serial ATA 1.0, Revision 1.0a - Serial ATA II Cables and Connectors Volume 2 Gold
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
USB	Universal Serial Bus Revision 1.1 Specification
USB 2.0	Universal Serial Bus Revision 2.0 Specification
SMBIOS	UEFI 2.1

Social and Environmental Responsibility	
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:
	 ENERGY STAR® (energy-saving features available on selected configurations -Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration
Recycled Content and Design for Recycling	Hewlett-Packard offers end-of-life HP product Return and recycling programs in many geographical areas. To recycle your product, please go to:
	http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Batteries	Batteries used in the product do not contain: • Mercury greater than 5ppm by weight
	 Cadmium greater than 10ppm by weight Lead greater than 40 ppm by weight.



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Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the the Environment: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf
	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.
	This product is brominated flame retardant and polyvinyl chloride free (BFR/PVC-free); meeting the evolving definition of "BFR/PVC-free" as set forth in the "iNEMI Position Statement on the 'Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free)." Plastic parts contain <1,000 ppm (0.1 percent) of bromine (if the Br source is from BFRs) and <1,000 ppm (0.1 percent) of chlorine (if the CI source is from CFRs or PVC or PVC copolymers). All printed circuit board (PCB) and substrate laminates contain bromine/chlorine total <1,500 ppm (0.15 percent) with a maximum chlorine of 900 ppm (0.09 percent) and maximum bromine being 900 ppm (0.09 percent). Service parts after purchase may not be BFR/PVC-free. Exceptions to this claim that may be shipped with the product include the power cord, keyboard, mouse and video adapters which may not be BFR/PVC-free.
Packaging	This product meets the packaging requirements specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf
	 Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency.
Packaging Materials	
External	Corrugated Carton. The Corrugated Carton packaging material is made from 100% recycled content.
Internal	EPE - Expanded Polyethylene, Polyethylene low density foam. The EPE - Expanded Polyethylene packaging material is made from 100% recycled content The Polyethylene low density foam packaging material is made from 100% recycled content
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Service, Support and Warranty	On-site Warranty and Service (Note 1): One and three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party



	hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.
	This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 5 years after the end of production.
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product contains 0% recycled materials (by weight) This product is >90% recycle-able when properly disposed of at end of life. For more details on the following please refer to the respective sections: Energy Consumption and Power Supply Efficiency Heat Dissipation Declared Noise Emissions

Visit: http://www.hp.com/go/easydeploy	
 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support. 	
Yes	
Visit: http://www.hp.com/go/easydeploy	
Visit: http://www.hp.com/go/ssm	
The HP Z210 workstations support Intel vPro technology when purchased with a vPro technology capable CPU: Intel® Xeon® processor E3-1200 family or 2nd Generation Intel Core i5/i7 processors with Intel VT and Intel TXT technology	
An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions: • Power Management (on, off, reset) • Hardware Inventory (includes BIOS and firmware revisions • Hardware Alerting	



- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.



Technical Specifications - Processors

Processors

Intel Xeon processor E3-1225, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, HD Graphics P3000, featuring Intel vPro Technology

Intel Xeon processor E3-1230, 3.20 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology

Intel Xeon processor E3-1240, 3.30 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology

Intel Xeon processor E3-1245, 3.30 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, HD Graphics P3000, featuring Intel vPro Technology

Intel Xeon processor E3-1270, 3.40 GHz, 80W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology

Intel Xeon processor E3-1280, 3.50 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, featuring Intel vPro Technology

Intel Core i3-2100 processor, 3.10 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT, Intel HD Graphics 2000

Intel Core i3-2120 processor, 3.30 GHz, 65W, 3 MB cache, 1333 MHz memory, Dual-Core, HT, Intel HD Graphics 2000

Intel Core i5-2400 processor, 3.10 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel HD Graphics 2000, featuring Intel vPro Technology

Intel Core i5-2500 processor, 3.30 GHz, 95W, 6 MB cache, 1333 MHz memory, Quad-Core, no HT, Intel HD Graphics 2000, featuring Intel vPro Technology

Intel Core i7-2600 processor, 3.40 GHz, 95W, 8 MB cache, 1333 MHz memory, Quad-Core, HT, Intel HD Graphics 2000, featuring Intel vPro Technology

Intel Pentium processor G850, 2.9 GHz, 65W, 3MB cache, 1333 MHz memory, Dual-Core, Intel HD Graphics 2000

Intel Pentium processor G620, 2.6 GHz, 65W, 3MB cache, 1066 MHz memory, Dual-Core, Intel HD Graphics 2000



Technical Specifications - Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations 600GB SATA 10K rpm SFF in 3.5" Frame HDD

Capacity 600GB Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0Gb/s)
Synchronous Transfer Up to 300MB/s

Rate (Maximum)

Buffer 32MB
Cache Segmentable

Seek Time (typical reads, includes controller overhead, including settling)

Single Track 0.4 ms (max)

Average 3.6 ms

Full Stroke 9.0 ms

Rotational Speed 10,000 rpm Logical Blocks 1,172,123,568

Operating Temperature 41° to 131° F (5° to 55° C)

300GB SATA 10K rpm SFF in 3.5" Frame HDD **Capacity** 300,069,052,416 bytes

Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing enabled

Synchronous Transfer Up to 300 MB/s

Rate (Maximum)

Raie (Maximoni)

Cache 16 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.7 ms (maximum)Average
9.5 ms4.4 ms

Rotational Speed 10,000 rpm Logical Blocks 586,072,368

Operating Temperature 41° to 131° F (5° to 55° C)

160GB SATA 10K rpm SFF in 3.5" Frame HDD **Capacity** 160,041,885,696 bytes

Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm

Up to 300 MB/s

Physical Size 4 in; 10.17 cm Serial ATA (1.5 Gb/s), Native Command

Queuing enabled

Synchronous Transfer

Rate (Maximum)

Interface

Buffer 16 MB



Technical Specifications - Hard Drives

Seek Time (typical reads, Single Track 0.7 ms (maximum)

includes controller overhead, including settling)

Average 4.4 ms

Full Stroke 9.5 ms

Rotational Speed 10,000 rpm Logical Blocks 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 1 Terabyte (1000 GB)
Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 msAverage
Full Stroke11 ms

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 500GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 msAverage11 msFull Stroke21 ms

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm 6Gb/s 3.5" HDD

 Capacity
 250 GB

 Height
 1 in; 2.54 cm



Technical Specifications - Hard Drives

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.17 cm

Up to 600MB/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer

8 MB

Seek Time (typical reads, Single Track 2 ms includes controller 11 ms Average overhead, including Full Stroke 21 ms settling)

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

HP Solid State Drives for Workstations

HP 160GB SATA X25-M SSD

160,041,885,696 bytes Capacity

0.28 in; 0.7 cm Height

Width Media Diameter NaN in; N/A cm

Physical Size 2.5 in; 6.36 cm

Interface SATA Synchronous Transfer 3Gb/s

Rate (Maximum)

Seek Time (typical reads, Read: 75 Average

includes controller overhead, including

settling)

microseconds; Write: 85 microseconds

Logical Blocks 312,581,808

Operating Temperature 32° to 158° F (0° to 70° C)

Technical Specifications - Graphics

Integrated Intel HD Graphics Media Accelerators (Z210) Form Factor Integrated

Graphics Controller Intel Integrated Graphics Media Accelerator HD

Bus Type PCI Express x16

Memory Unified Memory Architecture (UMA) frame buffer. Graphics memory is

shared with system memory. Size selectable between 64 MB to 512 MB via BIOS setting. Default size is 64 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel DVMT 5.0), to provide an optimal balance between graphics and system

memory use.

Connectors Z210: 1 Single Link DVI-I, 1 DisplayPort

Z210 SFF: 1 VGA, 1 DisplayPort

Graphics adapters are orderable as an accessory as necessary.

Maximum Resolution DVI-I: 1920 x 1200

Display Port: 2560 x 1600

RAMDAC Integrated, 350 MHz

Display Output Z210: Integrated dual independent monitor support facilitated via one DVI

port and one DisplayPort integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces. Second DVI supported via optional DisplayPort to DVI-D adapter. VGA support via optional DVI to

VGA adapter or DisplyPort to VGA adapter.

Z210 SFF: Integrated dual independent monitor support facilitated via one VGA port and one DisplayPort integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces. Second VGA supported via optional DisplayPort to VGA adapter. DVI support via optional

DisplayPort to DVI adapter.

Supported Graphics APIs Intel HD Graphics 2000: Microsoft DirectX 10, OpenGL 2.1

Intel HD Graphics P3000: Microsoft DirectX 10.1, OpenGL 3.0

NVIDIA Quadro NVS 295 Form Factor

256MB Graphics Card

Graphics Controller

Bus Type

2.731 inches (H) \times 6.600 inches (L), Half-Height NVIDIA Quadro NVS 295 Graphics Board

PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort

Comes with 2 DisplayPort to DVI-D Adapters

('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an

accessory)

Maximum Resolution

Two DisplayPort outputs drive two digital displays up to 2560 x 1600

NOTE: This card supports up to two displays

Display Output

 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking

ullet Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single link) cable)



Technical Specifications - Graphics

Supported Graphics APIs OpenGL 3.0

DirectX 10.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation (64-bit and 32-bit)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NVIDIA NVS 300 512MB Form Factor **Graphics Card**

Graphics Controller

Bus Type

Memory

Connectors

512 MB GDDR3 SDRAM unified graphics memory DMS-59

Includes DMS-59 to Dual DVI-I adapter

2.7 inches (H) x 5.7 inches (L), Half-Height

NVIDIA NVS 300 Graphics Board

PCI Express x16, Generation 2.0

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapter

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution

DVI: two digital displays up to 1920 x 1200 DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

Display Output

This card support up to two displays:

- ullet Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking
- Drives DisplayPort enabled digital displays at resolutions up to 2560 imes 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)
- Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

Supported Graphics APIs

OGL 3.3

DirectX 10.1

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)



Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

AMD FirePro 2270 512MB Graphics Card Form Factor Low Profile, Half Length, 2.3" x 6.6"

AMD FirePro™ 2270 Professional Graphics **Graphics Controller**

PCI Express[™] x16 Generation 2.0 **Bus Type**

512MB DDR3 Memory

Connectors DMS-59 connector to support breakout cables for dual DisplayPort, DVI and

VGA output.

DMS-59 to Dual DVI adapter included.

(Display Port and VGA adapters sold separately)

Maximum Resolution Digital 2560x1600 (DisplayPort)

Analog 1920x1200 (DVI 60 Hz/ VGA 75Hz)

RAMDAC 400 MHz DAC, 10-bit per channel **Display Output** Card supports up to two displays Supported Graphics APIs DirectX 11 and OpenGL 4.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption 17W Maximum

ATI FirePro V3800 512MB Graphics Card

Form Factor

2.71 in (H) x 6.61 in (L) "Single-Wide" ATI FirePro V3800 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

Connectors

Graphics Controller

512 MB DDR3 SDRAM 1 DL DVI, 1 DP output

One DP to DVI adapter included

Maximum Resolution

Up to two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays, one at resolutions up to 2048 x 1536 @ 85Hz, the other at

up to 1920 x 1200 @ 60Hz (165 MHz dot clock) NOTES: This card supports up to two displays

Use of more than two displays on Linux requires support for xrandr 1.2 or

greater in the X server

RAMDAC

400 MHz DAC, 10-bits per channel

Image Quality Features

• Full 30-bit display pipeline for more accurate color reproduction superior image quality (30-bit monitor required for full 30-bit display)

Advanced video capabilities, including high fidelity gamma, color correction and scaling

Dedicated hardware (UVD2) for H.264, VC-1, and MPEG2 decode



Technical Specifications - Graphics

Shading architecture

- Support for Full Shader Model 5.0
- 400 Stream Processing Units
- Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders
- Common instruction set and texture unit access supported for all types of shaders
- Dedicated branch execution units and texture address processors
- Anti-aliases Shaders and Textures as well as Polygon Edges

Supported graphics APIs

DirectX 11, OpenGL 3.2, OpenCL 1.0 and full implementation of DirectCompute 11

(OpenCL[™] compliant driver and SDK release scheduled in 2010)

Available graphics drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) WS4 * WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

43 Watts Power Consumption

NVIDIA Quadro 400 512MB Graphics Card Form Factor

Low Profile, 2.7 inches (H) x 5.6 inches (L)

Graphics Controller

NVIDIA Quadro 400 Graphics Board PCI Express x 16, Generation 2.0

Bus Type Memory

512MB DDR3 SDRAM

Connectors

One (1) Dual-link DVI-I

One (1) DisplayPort 1.1

Includes one DisplayPort to Dual DVI-D adapter

Maximum Resolution

DisplayPort 1.1: 2560 x 1600 @ 60 Hz Dual Link DVI-I: 2560 x 1600 @ 60 Hz

Analog: 2048 x1536 @ 85 Hz

RAMDAC

Dual internal 400 MHz DACs

Display Output

This card supports up to two displays

Supported Graphics APIs

OpenGL 3.2 DirectX 10.1 Shader Model 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Graphics

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption < 35 Watts

NVIDIA Quadro 600 1GB Graphics Card Form Factor 2.731" H x 6.6" L

Single Slot

Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16
Memory 1 GB GDDR3

128-bit

Connectors 1 DVI-I output, 1 DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Shading Architecture Shader Model 5.0

Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 and Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 40 Watts

Technical Specifications - Multimedia and Audio Devices

Integrated Intel/Realtek HD ALC261 Audio Minimum System Requirements

Integrated



Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) (15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

CD-ROM Mode 1 < 125 ms (typical)

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity

10% to 90%

Maximum Wet Bulb

86° F (30° C)

Temperature

Operating Systems Windows 7 Professional 32-bit and 64-bit, Supported Windows Vista Business 64*, Windows Vista

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

No driver is required for this device. Native support is provided by the

operating system.

* Certain Windows Vista product features require advanced or additional hardware. See

http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. Windows Vista Business disk also included for future upgrade if desired. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.

** RHEL WS4 not supported on Z200/Z200SFF

HP DVD+/-RW Drive Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)



Technical Specifications - Optical and Removable Storage

Supported Media Types DVD-RAM

DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Access Times Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

DVD+RW Up to 8X
DVD-RW Up to 8X
DVD+R DL Up to 8X
DVD-R DL Up to 8X
DVD-ROM Up to 16X
DVD-ROM DL Up to 8X
DVD+R Up to 16X
DVD-R Up to 16X

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -<1000 mA typical, <1600 mA

maximum

12 VDC -<600 mA typical, <1400 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 90% Maximum Wet Bulb 86° F (30° C)

Temperature

Operating Systems Supported

Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

No driver is required for this device. Native support is provided by the

operating system.

*Certain Windows Vista product features require advanced or additional hardware. See

http://microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:



Technical Specifications - Optical and Removable Storage

Description

http://www.windowsvista.com/upgradeadvisor. Windows Vista Business disk also included for future upgrade if desired. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements ** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP SATA SuperMulti DVD Writer Drive, Roxio Easy Media Creator software,

Intervideo WinDVD Software, installation guide, and DVD+R media.

HP 22-in-1 Media Card

Reader

The Media Card Reader device uses the same physical form factor and

mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash

memory card formats that are supported.

The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if Mounting Orientation

the chassis provides one) or in an appropriate Optical Bay adapter. It will

operate in any orientation.

Interface Type USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

Dimensions (WxHxD) 124.5 x 101.6 x 25.4 mm

 $(4.9 \times 4.0 \times 1.0 \text{ in})$

xD-Picture Supported Media Types

Micro SD Micro SDHC

SD **SDHC SDXC**

Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro

Memory Stick Micro (M2)



Technical Specifications - Optical and Removable Storage

HP Blu-ray Writer Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm

 $(5.9 \times 1.7 \times 8.0 \text{ in})$

Supported Media Types BD-ROM

BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-R DVD-RW

CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Blu-ray 50 GB DL or 25 GB standard

Access Times Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek) Blu-ray < 275 ms (seek)

Startup Time (Time to drive ready from tray loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S

DVD-RW 25S

DVD+R (SL/DL) 25S / 25S

DVD+RW 25S DVD-RAM 45S CD-ROM 15S

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM Up to 40X CD-R Up to 40X

CD-RW Up to 40X

DVD ROM Read DVD-RAM Up to 5X

DVD+RW Up to 10X DVD-RW Up to 10X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+R Up to 12X

DVD-R Up to 12X

Technical Specifications - Optical and Removable Storage

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 4.8X

BD-R Up to 6X BD-R DL Up to 4.8X BD-R Up to 6X

BD-RE SL/DL Up to 4.8X

Power Source SATA DC power receptacle

> $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$ DC Power Requirements

 $12 \text{ VDC} \pm 10\%$ -100 mV ripple p-p

DC Current 5 VDC -900 mA typical, 1200 mA maximum

12 VDC -1000 mA typical, 1600 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 15% to 80% Maximum Wet Bulb 86° F (30° C)

Temperature

Operating Systems Supported

Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media Creator software, Intervideo

WinDVD Software, installation guide.

Disclaimer As Blu-ray is a new format containing new technologies, certain disc, digital

> connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support.

HD-DVD movies cannot be played on this workstation.

Technical Specifications - Networking and Communications

Integrated Intel 82579LM Connector RJ-45

PCle GbE Controller

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCle-based interface for active state operation (S0 state) and SMBus for host

and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

AMT 7.0 support

Intel Gigabit CT Desktop Connector

NIC

nnector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mb/s

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature 32° to 131°F (0° to 55°C)
Operating Humidity 85% at 131°F (55°C)

Dimensions (H x W x D) 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)



Technical Specifications - Networking and Communications

Support

Operating System Driver Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5

(RHEL5.3 or newer), Red Hat Enterprise Linux 6

* RHEL WS4 not supported on Z200/Z200SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents

Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

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